



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:	§	Art Unit:	2814
Ilya Karpov et al.	§		
	§	Examiner:	Long Pham
Serial No.: 10/822,361	§		
	§	Docket:	ITL.0835D1US
Filed: April 12, 2004	§		P14730D
	§		
For: Fabricating Deeper and Shallower	§	Assignee:	Intel Corporation
Trenches in Semiconductor Structures	§		
	§	Conf. No.	3077

Mail Stop **RCE**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT ACCOMPANYING REQUEST FOR CONTINUED EXAMINATION**

Sir:

Pursuant to 37 C.F.R. § 1.114(c), please consider the following claim amendments and remarks.

Date of Deposit: December 21, 2006

I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as **first class mail** with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

  
Nancy Meshkoff